

NASDAQ OMX Copenhagen Nikolaj Plads 6 1067 Copenhagen K, Denmark

Frederikssund, 3 January 2013

## **COMPANY ANNOUNCEMENT NO. 1/13**

## Next silicon wafer generation submitted for customer qualification

Topsil has just submitted the first 200 mm diameter NTD silicon wafers for qualification with one of the company's major contract customers. Due to the duration of the qualification process, the new 200 mm NTD product is not expected to be a significant revenue contributor in 2013.

The product submission will be in line with the company's previously announced expectations.

Please direct any questions regarding this announcement to Kalle Hvidt Nielsen, CEO, tel.: +45 4025 6700.

## **Topsil Semiconductor Materials A/S**

Jens Borelli-Kjær Kalle Hvidt Nielsen Chairman of the Board of Directors CEO

This announcement has been prepared in a Danish-language and an English-language version. In case of discrepancies, the Danish version **shall prevail.** 

## STOCK EXCHANGE ANNOUNCEMENT